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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicants: Yoram Cedar, Micky Holtzman and Yosi Pinto
Assignee: SanDisk Corporation
Title: Multiple Removable Non-Volatile Memory Cards Serially
Communicating With a Host
Application No.: 09/641,023 Filing Date: August 17, 2000
Examiner: Auve, Glenn Allen Group Art Unit: 2181
Docket No.: SNDK.158US0 Conf. No.: 4831

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

DECLARATION OF APPLICANTS UNDER 37 C.F.R. § 132

Sir:

The undersigned declare, under penalty of perjury under the laws of the United States of America, that the following is true and correct:

1. We are the named applicants of the above-identified patent application (the "Present Application"), which we have assigned to SanDisk Corporation of Sunnyvale, California ("SanDisk"). We have been employed by SanDisk during the entire time of the activities described herein, continuously from prior to the August 17, 2000 filing of the Present Application until the present. Each of us has personal knowledge of the matters set forth in this Declaration and, if called upon to testify, could competently testify thereto.

2. As part of our work to develop a new flash memory card, which has become known as the "SD Memory Card," we worked with other employees of SanDisk and engineers of Toshiba Corporation ("Toshiba") and Matsushita Electric Industrial Co., Ltd. ("MEI"), both of Japan, to generate a set of structural, electrical and operational standards for

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the card. One result of this work was a document entitled "SD Memory Card Specifications, Part 1, Physical Layer Specification, Version 1.0," dated March 22, 2000 ("SD Specification 1.0"). We participated in discussions of the subject matter described in this document and in its drafting.

3. SanDisk, Toshiba and MEI (together, the "3C") agreed in August 1999 to jointly develop, specify and promote the next generation of secure memory card. In January 2000, the 3C formed the SD Card Association ("SDA") with an expanded membership to set standards for the SD Memory Card and promote its wide acceptance in digital applications. Prior to the August 20, 2000 filing of the Present Application, the SD Specification 1.0 was made available under confidence to companies joining the SDA.

4. A non-confidential version of an early draft of the SD Specification 1.0, entitled "SD Memory Card Simplified Specifications" and dated January 2000, was prepared for unrestricted public distribution. This Simplified version omits many sections of the SD Specification 1.0.


5. A document entitled "Supplementary Notes for: SD Memory Card Specifications, Part 1, Physical Layer Specification, Version 1.0, March 2000" and dated June 2000 includes 8 clarifications and updates of the SD Specification 1.0. These Supplementary Notes resulted from work of us, others at SanDisk and engineers of Toshiba and MEI.

6. The descriptions in the forgoing identified documents of the subject matter claimed in the Present Application are descriptions derived from us of subject matter conceived and invented by us.


Each of us declares that all statements made herein of our own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements are made herein with the knowledge that, in any document to be filed in the United States

Patent and Trademark Office, willful false statements and the like are punishable, including fine or imprisonment or both, as set forth in 18 U.S.C. § 1001, and may jeopardize the validity of the Present Application and any patent issuing therefrom.

Executed this 2 day of ~~September~~^{October} 2003, in San Francisco, California.

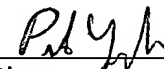


Yoram Cedar



Micky Holtzman

Executed this 3 day of ~~September~~^{October} 2003, in Sunnyvale, California.



Yosi Pinto